APPLICA	BLE STAN	IDARD										
	Operating temperature range Voltage		-55 °C to 85 °C 30 V AC / DC			• •	perature	-10 ℃ to 50 ℃ (packed		ed cond	lition)	
RATING					range Operating o humidity rar		-	Relati	Relative humidity 90%MAX(r		,	
	Current		0.20 A			cable ca		t	=0.12±0.02mm, go	ld platin	na	
	Current			CIFIC					_0.12 <u>↓</u> 0.0211111, go	iu platil	iy	
										0.7		
			TEST METHO	)			RE	QUIRE	MENTS	QT	A	
General exa		Vieuelly	and by managuring instrum	ont		Accord	ing to draw	ina			١.	
	mination	-	Visually and by measuring instrument. Confirmed visually.				ing to uraw <b>1,2</b> )	nng.		×	>	
Marking			•			`				×	>	
	ICAL CHA					NI- (1					-	
• •		90 V AC					hover or br	eakdo	wn.	×	>	
Insulation re	sistance	100 V DC	100 V DC.				MIN.			×	>	
Contact resistance AC		AC 20 m	AC 20 mV MAX (1KHz), 1 mA.			200 m $\Omega$ MAX. Including FPC bulk resistance (L=8mm)				×	>	
			RISTICS			moluum	ig i i o bui	10313				
Vibration			y 10 to 55 Hz, half amplit	ude 0.75 m	nm,	<ol> <li>No</li> </ol>	electrical d	isconti	nuity of 1 us	×	-	
		for 10 cycles in 3 axial directions.			,	<ol> <li>No electrical discontinuity of 1 μs.</li> <li>Contact resistance: 200 mΩ MAX.</li> </ol>						
Shock S		at 3 times	981 m/s <sup>2</sup> , duration of pulse 6 ms at 3 times in 3 both axial directions.			<ol> <li>No damage, crack and looseness of parts.</li> </ol>			s. ×	-		
Mechanical operation 10		10 times	insertions and extractions	3.		<ol> <li>Contact resistance: 200 mΩ MAX.</li> <li>No damage, crack and looseness of parts.</li> </ol>			s. ×	-		
(thick		(thicknes	Measured by applicable FPC. (thickness of FPC shall be t=0.12mm at initial condition)			Direction of insertion: (0.15 × n)+0.7N MIN(note3) (n: Number of contacts)				-		
Corrosion sa			at 35±2°C, 5% salt wate	er sprav for	96 h.	Contac	t resistance	e: 200	mΩ MAX.	×	1_	
			,							~		
temperature		Time	Temperature $-55 \rightarrow +15$ to $+35 \rightarrow +85 \rightarrow +15$ to $+35^{\circ}$ C Time $30 \rightarrow 2$ to $3 \rightarrow 30 \rightarrow 2$ to $3$ min Under 5 cycles.			<ol> <li>Contact resistance: 200 mΩ MAX.</li> <li>Insulation resistance: 50 MΩ MIN.</li> <li>No damage, crack and looseness of parts.</li> </ol>				×	-	
Damp heat	\ \	Exposed	at 40±2°C,			U NO	damage, o			, ×	-	
(steady state Damp heat,c	-		humidity 90 to 95 %, 96 h	1.		① Cor	tact registr	2000: 2		~	_	
Damp neat,c	yono	Exposed at -10 to +65°C, Relative humidity 90 to 96 %,			<ol> <li>Contact resistance: 200 mΩ MAX.</li> <li>Insulation resistance: 1 MΩ MIN.</li> </ol>				×	-		
			s, total 240 h.				at high hum					
						(3) Insulation resistance: 50 M $\Omega$ MIN.						
						•	at dry)					
Dry heat Expo		Exposed	ed at 85±2°C, 96 h.			<ul> <li>④ No damage, crack and looseness of parts.</li> <li>① Contact resistance: 200 mΩ MAX.</li> </ul>					_	
;			sed at -55±3°C, 96 h.			<ol> <li>Contact resistance. 200 mg MAX.</li> <li>No damage, crack and looseness of parts.</li> </ol>				s. ×	+	
Sulphur diox	ide	-	at $40\pm2^{\circ}C$ ,			Contact resistance: 200 m $\Omega$ MAX.				×	+	
[JIS C 60068-2-42] R		] Relative	lative humidity $80\pm5\%$ $\pm5$ ppm for 96 h.								-	
Hydrogen su		Exposed	at 40±2°C,							×	†-	
		] Relative	humidity $80\pm5\%$ , ppm for 96 h.									
COUN	T DI		ON OF REVISIONS		DESIG	NED			CHECKED	D	DATE	
REMARK					APPROVE	ED NF. MIYAZAKI		17.	17.02.2			
							CHECKE	D	YH. MICHIDA	17.	02. 2	
							DESIGNE	D	HY. YAMAZAKI	17.	02. 2	
Jnless oth	nerwise spe	cified, re	fer to IEC 60512.				DRAWN	1	RK. OGASAWARA	17.	02.2	
			surance Test X:Applicable	e Test	DF	RAWIN	G NO.		ELC-375451-			
LDC SPECIFICATION SHEET PAR			PART	т NO. FH64MA-**S-0. 25SHV			HW					
RS			ECTRIC CO., LTI			CODE NO. CL580		⋒	1/			
ORM HD0011-				-	JUDE						.,	

FORM HD0011-2-1

SPECIFICATIONS								
ITEM	TEST METHOD	REQUIREMENTS	QT	AT				
Solderability	Soldered at solder temperature, 245±3°C for immersion duration, 3±0.3 sec.	A new uniform coating of solder shall cover a minimum of 95% of the surface being immersed.	×	-				
Resistance to soldering heat	<ol> <li>Reflow soldering : Peak TMP. 250°C MAX . Reflow TMP. over 230°C within 60 sec. Number of allowed reflow cycles 2 times.</li> <li>Soldering irons : TMP. 350±10°C for 5±1 sec .</li> </ol>	No deformation of case of excessive looseness of the terminals. ( <i>note 4</i> )	×	_				

## (note1)

This is a top contact point connector with back flip lock system.

## (note2)

Do not close the actuator before inserting FPC even after the connector is mounted onto a PCB. Closing the actuator without FPC could make the contact gap smaller, which increases the FPC insertion force.

## (note3)

Stabilize the FPC to PCB or something fixed, if pull-up or pull-down force is exepected to be applied to the FPC. There is a case which the FPC retention force doesn't fullfill the specification depending on the FPC specification.

## (note4)

Blisters which may be generated on the housing do not affect product performance.

Note QT:C	Qualification Test AT:Assurance Test X:Applicable Test	DRAWIN	IG NO.	ELC-375451-00-00		
HRS	SPECIFICATION SHEET	PART NO.	FH	FH64MA-**S-0. 25SHW		
	HIROSE ELECTRIC CO., LTD.	CODE NO		CL580		2/2